

PMEG100T30ELR-Q

100 V, 3 A low leakage current Trench MEGA Schottky barrier rectifier

19 May 2021

Product data sheet

1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP3 (SOD123W) small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low Q_{rr} and low I_{RM}
- · Low leakage current
- · High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High efficiency DC-to-DC conversion
- · Automotive LED lighting
- Switch mode power supply
- Freewheeling applications
- Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--------------------|-------------------------|---|-----|-----|------|------|------|
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 153 °C | | - | - | 3 | Α |
| V_R | reverse voltage | T _j = 25 °C | | - | - | 100 | V |
| V _F | forward voltage | I _F = 3 A; pulsed; T _j = 25 °C | [1] | - | 705 | 800 | mV |
| I _R | reverse current | V _R = 100 V; pulsed; T _j = 25 °C | [1] | - | 0.25 | 1.75 | μΑ |
| | | V_R = 100 V; pulsed; T_j = 125 °C | [1] | - | 0.42 | 2.2 | mA |

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--------------------|------------------------|
| 1 | K | cathode[1] | 1 2 | К <u>-К-</u> -А |
| 2 | А | anode | CFP3 (SOD123W) | sym001 |

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

| Type number | | | |
|-----------------|------|--|---------|
| | Name | Description | Version |
| PMEG100T30ELR-Q | CFP3 | plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body | SOD123W |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-----------------|--------------|
| PMEG100T30ELR-Q | LC |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------|-------------------------------------|---|-----|-----|------|------|
| V _R | reverse voltage | T _j = 25 °C | | - | 100 | V |
| l _F | forward current | δ = 1; $T_{sp} \le 147 ^{\circ}\text{C}$ | | - | 4.2 | А |
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 153 °C | | - | 3 | A |
| I _{FSM} | non-repetitive peak forward current | t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C | | - | 70 | A |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [1] | - | 0.68 | W |
| | | | [2] | - | 1.15 | W |
| Tj | junction temperature | | | - | 175 | °C |
| T _{amb} | ambient temperature | | | -55 | 175 | °C |
| T _{stg} | storage temperature | | | -65 | 175 | °C |

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

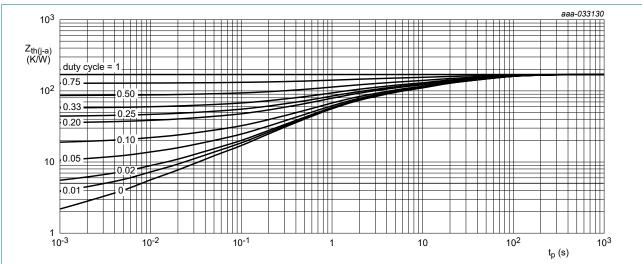
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

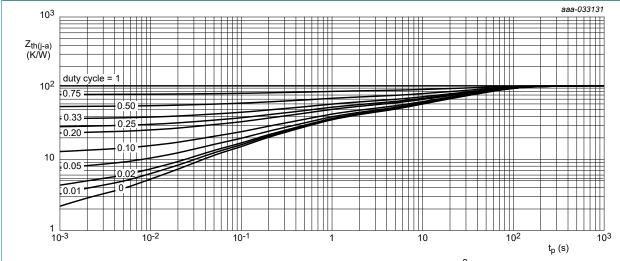
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|----------------------|--|------------------|---------|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from | in free air | [1] [2] | - | - | 220 | K/W |
| junction | junction to ambient | ction to ambient | [1] [3] | - | - | 130 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | [4] | - | - | 18 | K/W |

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, single-sided copper, tin-plated and standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided copper, tin-plated and mounting pad for cathode 1 cm²

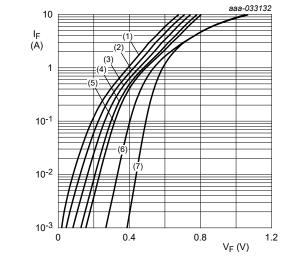
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|-------------------------------------|---|-----|-----|------|------|------|
| $V_{(BR)R}$ | reverse breakdown voltage | I _R = 1 mA; pulsed; T _j = 25 °C | [1] | 100 | - | - | V |
| V _F | forward voltage | I _F = 0.5 A; pulsed; T _j = 25 °C | [1] | - | 480 | 550 | mV |
| | | I _F = 1 A; pulsed; T _j = 25 °C | [1] | - | 540 | 610 | mV |
| | | I _F = 2 A; pulsed; T _j = 25 °C | [1] | - | 630 | 710 | mV |
| | | I _F = 3 A; pulsed; T _j = 25 °C | [1] | - | 705 | 800 | mV |
| | | $I_F = 3 \text{ A}$; pulsed; $T_j = -40 ^{\circ}\text{C}$ | [1] | - | 705 | 800 | mV |
| | | I _F = 3 A; pulsed; T _j = 125 °C | [1] | - | 580 | 650 | mV |
| | | I _F = 3 A; pulsed; T _j = 150 °C | [1] | - | 545 | 620 | mV |
| I _R | reverse current | V _R = 60 V; pulsed; T _j = 25 °C | [1] | - | 0.1 | 0.8 | μA |
| | | V _R = 100 V; pulsed; T _j = 25 °C | [1] | - | 0.25 | 1.75 | μA |
| | | V _R = 100 V; pulsed; T _j = 125 °C | [1] | - | 0.42 | 2.2 | mA |
| | | V _R = 100 V; pulsed; T _j = 150 °C | [1] | - | 1.65 | 8 | mA |
| C _d | diode capacitance | V _R = 1 V; f = 1 MHz; T _j = 25 °C | | - | 310 | - | pF |
| | | V _R = 10 V; f = 1 MHz; T _j = 25 °C | | - | 90 | - | pF |
| t _{rr} | reverse recovery time step recovery | $I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $I_{j} = 25 \text{ °C}$ | | - | 9 | - | ns |
| | reverse recovery time ramp recovery | $dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$ | | - | 12.5 | - | ns |
| I _{RM} | peak reverse recovery current | $dI_F/dt = 200 \text{ A/s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$ | | - | 1.3 | - | А |
| Q _{rr} | reverse recovery charge | | | - | 10 | - | nC |
| V_{FRM} | peak forward recovery voltage | $I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A/µs}; T_j = 25 ^{\circ}\text{C}$ | | - | 480 | - | mV |

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) $T_j = 175 \,^{\circ}C$

(2) Tj = 150 °C

(3) Tj = 125 °C

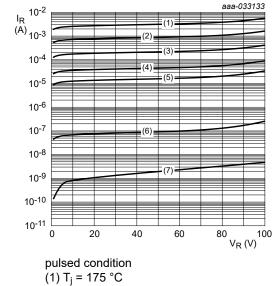
(4) Tj = 100 °C

(5) Tj = 85 °C

(6) Tj = 25 °C

(7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



(2) T_{i} = 150 °C

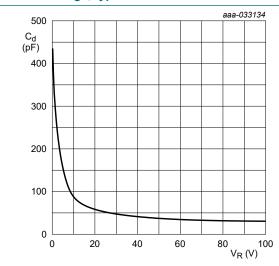
 $(3) T_j = 125 °C$

 $(4) T_j = 100 °C$

(5) $T_j = 85 ^{\circ}C$ (6) $T_i = 25 ^{\circ}C$

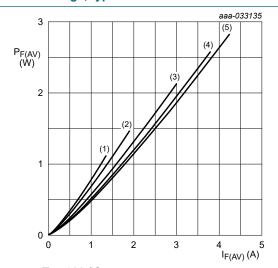
(7) $T_i = -40$ °C

Fig. 4. Reverse current as a function of reverse voltage; typical values



f = 1 MHz; T_{amb} = 25 °C

Fig. 5. Diode capacitance as a function of reverse voltage; typical values



T_j = 100 °C

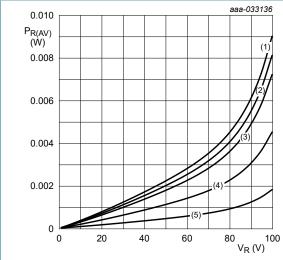
 $(1) \delta = 0.1$

 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

(4) $\delta = 1$; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 100 \, ^{\circ}C$

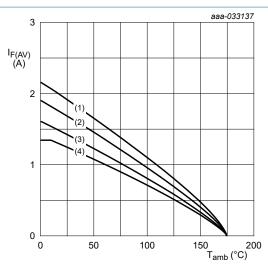
 $(1) \delta = 1$; DC

 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$ (5) $\delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

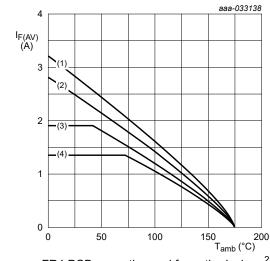
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

T_i = 175 °C

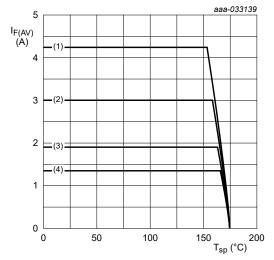
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

(1) δ = 1; DC

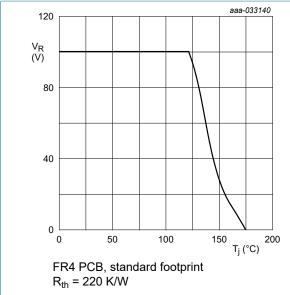
(2) δ = 0.5; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

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of junction temperature; typical values

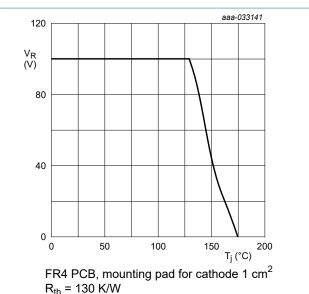
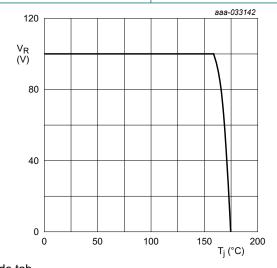


Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



Soldering point of cathode tab

 $R_{th} = 18 \text{ K/W}$

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

11. Test information

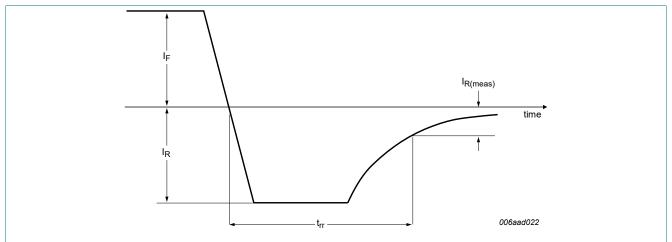


Fig. 14. Reverse recovery definition; step recovery

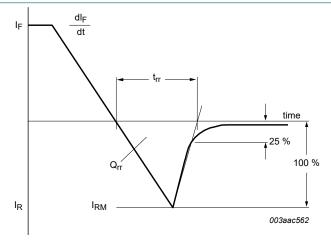


Fig. 15. Reverse recovery definition; ramp recovery

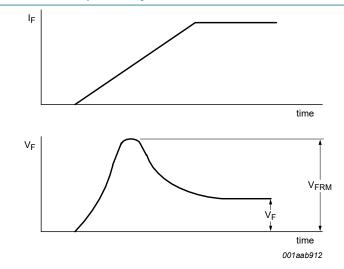
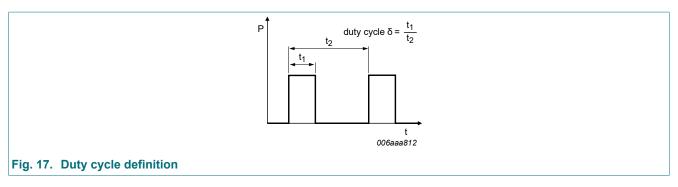


Fig. 16. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

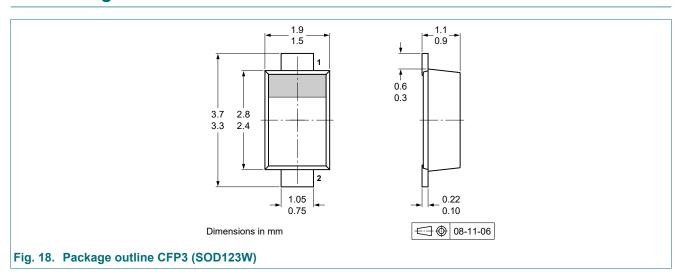
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

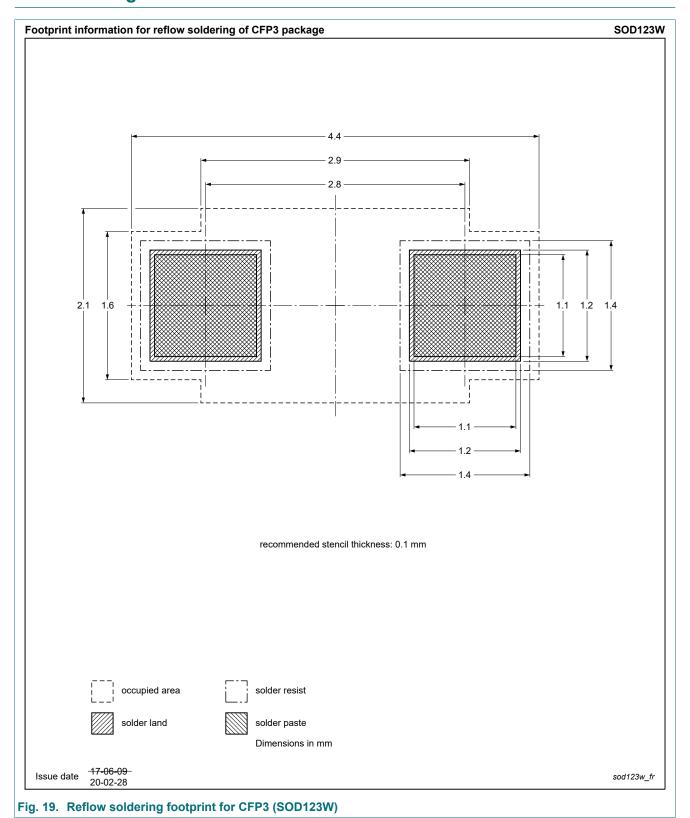
Quality information

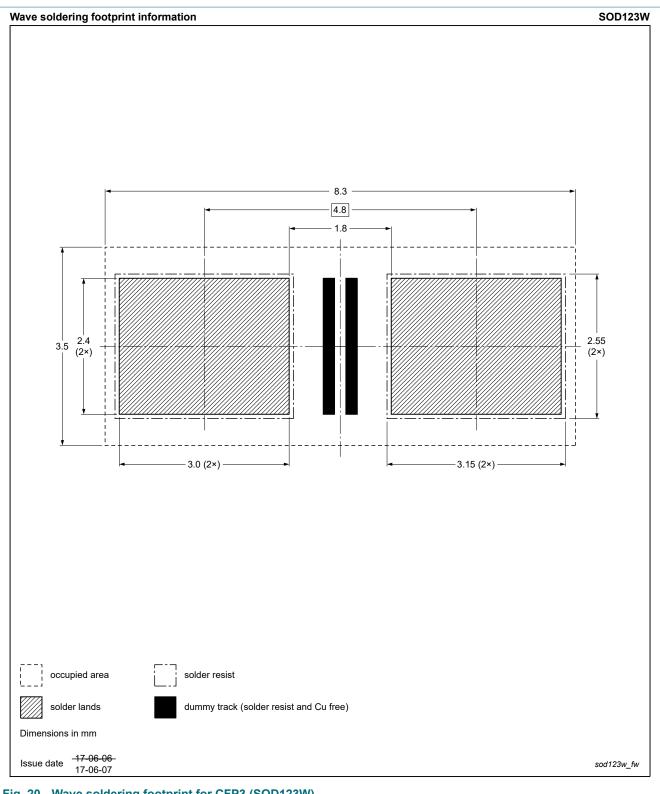
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

| Table of Noticin motory | | | | | | | | |
|-------------------------|---|--------------------|---------------|---------------------|--|--|--|--|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | | | |
| PMEG100T30ELR-Q v.2 | 20210519 | Product data sheet | - | PMEG100T30ELR-Q v.1 | | | | |
| Modifications: | Characteristics: Diode capacitance corrected and Fig. 5 adapted | | | | | | | |
| PMEG100T30ELR-Q v.1 | 20210311 | Product data sheet | - | - | | | | |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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